EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("20070134838").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/24 10:05
L2	2	("20020145489").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/24 10:09
L3	3	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) near2 lateral$4) and 438/48. ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:32
L4	22	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) near2 lateral$4) and 438/48,50,52.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:36
L5	415	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4)) and 438/48,50,52.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:37
L6	331	l5 and (impurit$4 or ion$3 or dop$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:37
L7	631	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) or suspended) and 438/48,50,52.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:37

L8	492	l7 and (impurit$4 or ion$3 or dop$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:38
L9	401	l8 and oxide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:38
L10	309	l9 and (trench$2 or groov$2 or por$3 or hole$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:39
L11	293	l10 and (electrode$2 or contact$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 10:39
L12	44	patrice near gamand	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:01
L13	3	patrice gamand.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:02
L14	46	douvres near la near delivrande	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:07
L15	0	douvres la delivrande.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:08
L16	13809	koninklijke near philips	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:09

L17	163	l16 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:09
L18	105	(resonat$6 and semiconductor and (hole or trench or groove or pore or porous) and (ion or dop$3 or impurit$3)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:13
L19	39	(resonat$6 and semiconductor and (hole or trench or groove or pore or porous) and (ion or dop$3 or impurit$3) and (elecrode$2 or contact$2)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 11:19
L23	19	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) near2 lateral$4) and 257/107-108,252,254,414-416,618-619,E21.001, E21.002,E04,E21.459, E21.476,E21.481,E21.518, E29.324.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:44
L24	1243	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) or suspen$6) and 257/107-108,252,254,414-416,618-619,E21.001,E21.002,E04, E21.459,E21.476,E21.481, E21.518,E29.324.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:45
L25	761	l24 and (trench$2 or groov $2 or por$3 or hole$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:45
L26	720	l25 and (electrode$2 or contact$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:46

L27	460	I26 and (impurit$4 or ion$3 or dop$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:46
L28	385	I27 and (semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:46
L29	138	I28 and ("MEMS" or (micro near mechanic$6) or micro $2electro$2mechanical or "MEM")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/24 13:47
S1	27581751	@ad< "20031114"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:02
S2	101491	S1 and "438"/$.ccls. and "257"/$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:04
S3	734	S2 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 16:05
S4	2	("20070134838").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/04/22 16:05
S5	48	S3 and (dop$3 with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:11
S6	2	S3 and ("argon" with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:16

S7	319	S1 and "257"/118,244,328-333,466,513,594.ccls. and "438"/242,268-274.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:18
S8	11	S7 and (first near doping)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:19
S9	0	S7 and (dop$3 near2 argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S10	0	S7 and (dop$6 with argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S11	3	S7 and (dop$6 same argon)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:20
S12	95239	S1 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:25
S13	489	S12 and (dop$3 with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S14	231	S12 and (dop$3 near5 (trench or hole$2 or recess $3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S15	0	S12 and (dop$3 near5 argon near5 (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30

S16	0	S12 and (dop$3 with argon with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:30
S17	11	S12 and (dop$3 with boron with (trench or hole$2 or recess$3 or groove$2))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:31
S18	48632	S2 and (trench$2 or hole$2 or pore$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:36
S19	44	S18 and (high near ohmic)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/04/22 17:37
S20	376044	@ad<"20031114" and ("257"/$.ccls. or "438"/$.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:23
S21	3218	S20 and resonator$2	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:24
S22	1101	S21 and oxide and (implant$4 or dop$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:35
S23	496	S22 and (argon or boron)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:35
S24	475052	mems	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:45

S25	13387	micro electro mechanical system	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:45
S26	42	(micro-electro-mechanical-system) and (cantilever beam)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:47
S27	69	(micro-electro-mechanical-system) and (resonator)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 17:49
S28	381	(rf transceiver) and (resonator$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:05
S29	74	(rf transceiver) and (resonator$2) and (dop$4 or implant$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:12
S30	4203	(transceiver) and (mems)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:13
S31	33	(rf transceiver) and (resonator$2) and (dop$4 or implant$4) and mems	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:13
S32	1490	(resonator$2) and (dop$4 or implant$4) and "mems"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:14
S33	1012	(resonator$2) and (dop$4 or implant$4) and "mems" and oxide	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:14

S34	754	S33 and electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:15
S35	576	S33 and electrode and (trench or groove or hole or pore)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:15
S36	300	S33 and electrode and (trench or groove)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:16
S37	147	S36 and (argon or boron or "ar" or "br")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/01 18:16
S38	9035	@ad<"20031114" and (resonat$5 or cantilever$3) and (doping or implant$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:07
S39	2483	S38 and (trench$3 or groove $3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:07
S40	1715	S39 and etch$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:08
S41	503	S40 and (sacrificial or release)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:08
S42	273176	@ad<"20031114" and (resonat$5 or cantilever$3 or mems)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:37

S43	2926	S42 and ((dop$5 or implant $5) near3 (substrate or trench or groove))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:38
S44	2265	S42 and ((dop$5 or implant $5) near2 (substrate or trench or groove))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:38
S45	758	S42 and (((dop$5 or implant $5) near2 (substrate or trench or groove)) same (oxide or insulat$5 or dielectric))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:39
S46	277	S42 and (((dop$5 or implant $5) near2 (substrate or trench or groove)) same (oxide or insulat$5 or dielectric) same (etch$3 or remov$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 00:39
S47	2	("20040048410").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/07/03 10:51
S48	42	(Patrice near Gamand)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 12:40
S49	0	(douvres near delivrande)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/07/03 12:40
S50	10782	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) near4 lateral$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/12/19 12:52
S51	7928	(@pd<"20031114" or @ad<"20031114" or @prad<"20031114" or @rlad<"20031114") and ((resonat$6 or vibrat$4) near2 lateral$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/12/19 12:52

S52	429	S51 and ((two or second or other or another) near2 electrode$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/12/19 12:53
S53	137	S52 and (mems or micro)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/12/19 12:53
S54	23	S53 and ("257"/$.ccls. or "438"/$.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/12/19 12:54

2/24/2009 1:58:53 PM
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